



Ceramic High Power

6868 3.7t Series

UV (390~400nm)

PRODUCT DATASHEET



N0Q52S20Z



Release Date: 10 September 2020 Version: A1.0



APPLICATIONS:

- Industrial Curing
- Counterfeit Detection
- Medical Device
- Fluorochemistry
- Bacterial Identification
- Cosmetology
- Magnetic Particle Inspection
- Clean Room Inspection
- Mineralogy

6868 3.7t Series



FEATURES:

- Package: Ceramic SMT Package with Quartz Glass Lens
- Forward Current: 700mA
- Forward Voltage (typ.): 14.4V
- Radiant Power (typ.): 5500mW@700mA
- Colour: Ultraviolet (UV)
- Wavelength: 390~400nm
- Viewing angle: 60°
- Materials:

.

- Die: InGaN
- Resin: Quartz Glass (Water Clear)
- L/F: AIN
- **Operating Temperature:** -40~+80°C
- Storage Temperature: -40~+100°C
- ESD: 8KV (HBM: MIL-STD-883 Class 3B)
- Grouping parameters:
 - Forward voltage
 - Radiant power
 - Peak Wavelength
- Soldering methods: Reflow soldering
- MSL: Level 4 according to J-STD020
- Packing: 16mm tape with min.100pcs/reel, ø180mm (7")

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Absolute Maximum Characteristics (Ta=25°C)

Parameter	Symbol	Ratings	Unit
Maximum Forward Current	Imax	1000	mA
Pulse Forward Current (D=0.01s; Duty 1/10)	Ipf	1200	mA
Reverse Voltage	V _R	-20	V
Reverse Current @5V	IR	10	μΑ
Electrostatic Discharge (HBM)	ESD	8000	V
Junction Temperature	Tj	85	°C
Thermal Resistance Junction to Solder Point	R _{THJS}	2.0	°C/W
Operating Temperature	Topr	-40~+80	°C
Storage Temperature	T _{STG}	-40~+100	°C
Solder Temperature	Tsol	260	°C

Electrical & Optical Characteristics (Ta=25°C)

Darameter	Parameter Symbol	Values			Unit	Test
Farameter		Min.	Тур.	Max.	Onit	Condition
Forward Voltage	VF	12.0		16.8	V	I⊧=700mA
Radiant Power	Po	4500		6500	mW	I⊧=700mA
Wavelength	W _P	390		400	nm	I _F =700mA
Viewing Angle	2 θ 1/2		60		deg	I⊧=700mA

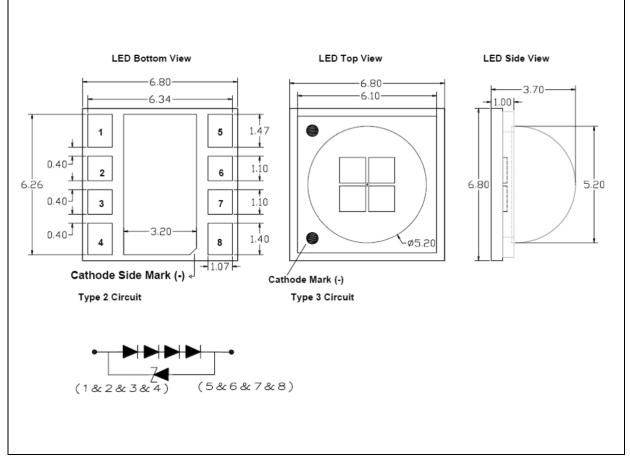
1. Radiant Power (P₀) ±10%, Forward Voltage (V_F) ±0.2V, Viewing angle($2\theta_{1/2}$) ±10°, Wavelength (nm) ±2nm

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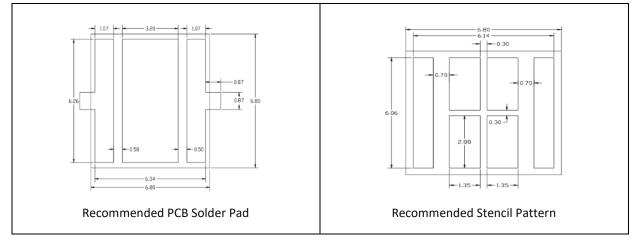


Package Dimension:



- 1. All dimensions are in millimetre (mm).
- 2. Tolerance ± 0.13 mm, unless otherwise noted.

Recommended Soldering Pad Dimension:



- 1. Dimensions are in millimetre (mm).
- 2. Tolerance ± 0.12 mm with angle tolerance $\pm 0.5^{\circ}$.





Forward Voltage Classifications (I_F = 700mA):

Code	Min.	Max.	Unit
СО	12.0	12.8	
C1	12.8	13.6	
C2	13.6	14.4	V
C3	14.4	15.2	v
C4	15.2	16.0	
C5	16.0	16.8	

Radiant Power Classifications (I_F = 700mA):

Code	Min.	Max.	Unit
P35	3000	3500	
P40	3500	4000	
P45	4000	4500	mW
P50	4500	5000	

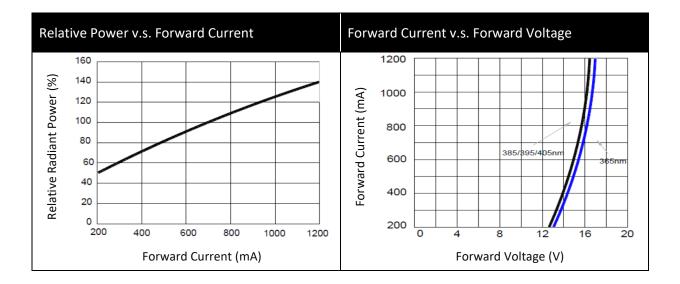
Wavelength Classifications ($I_F = 700 \text{ mA}$):

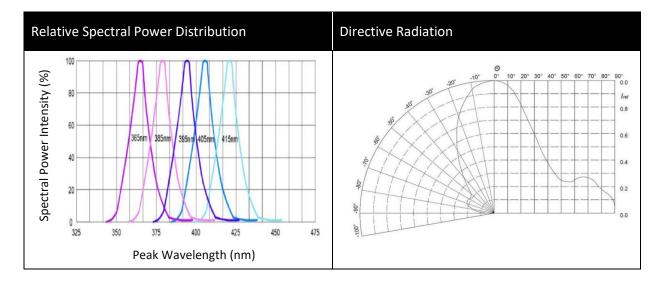
Code	Min.	Max.	Unit
UV395	390	400	nm

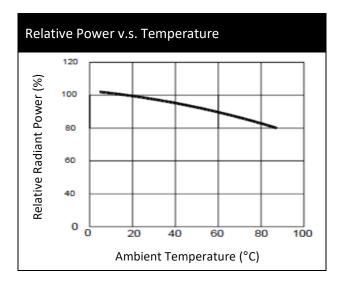




ELECTRO-OPTICAL CHARACTERISTICS:





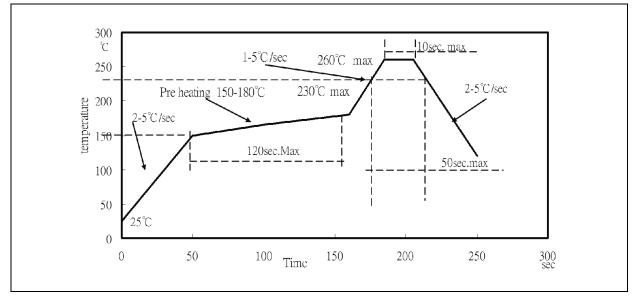






RECOMMENDED SOLDERING PROFILE:

Lead-free Solder:



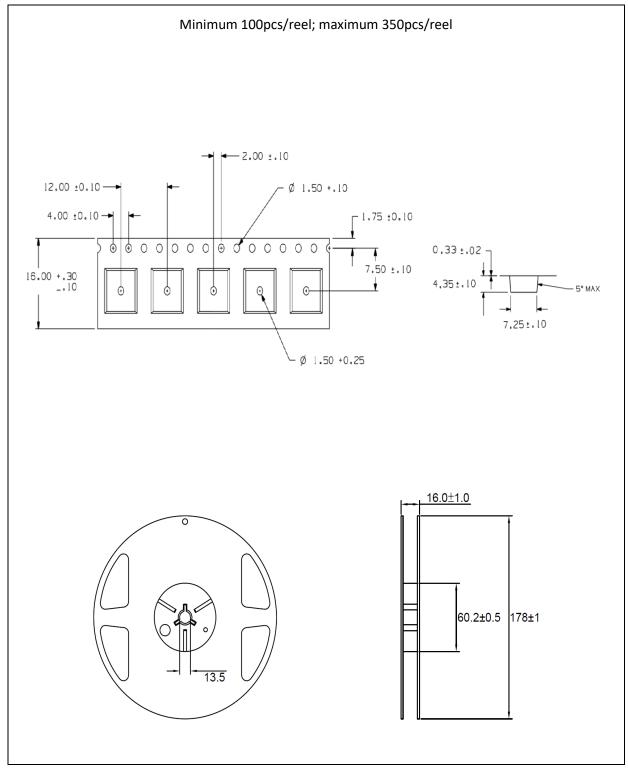
Note:

- 1. Maximum reflow soldering: 2 times.
- 2. Recommended reflow temperature 240°C. Maximum soldering temperature should be limited to 260°C.
- 3. Before, during, and after soldering, should not apply stress on the components and PCB board.





Reel Dimension:



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Storage:

It is recommended to store the products in the following conditions:

- Humidity: 60% R.H. Max.
- Temperature: 5°C~30°C (41°F ~86°F).

Shelf life in sealed bag: 12 months at 5°C~30°C and <60% R.H.

Once the package is opened, the products should be used within 72 hours. Otherwise, they should be kept in a damp-proof box with descanting agent <10% R.H. and apply baking.

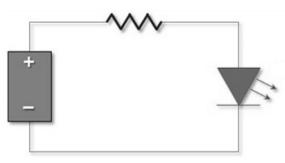
Baking:

It is recommended to bake the LED before soldering if the pack has been unsealed for longer than 24hrs. The suggested baking conditions are as followings:

• 60±3°C x 24hrs and <5%RH, taped / reel package.

It's normal to see slight color fading of carrier (light yellow) after baking in process.

Testing Circuit:



Must apply resistor(s) for protection (over current proof).

Cleaning:

Use alcohol-based cleaning solvents such as isopropyl alcohol to clean the LED carrier / package. Avoid putting any stress force directly on to the LED lens.

ESD (Electrostatic Discharge):

Static Electricity or power surge will damage the LED. Use of a conductive wrist band or anti-electrosatic glove is recommended when handing the LED all time. All devices, equipment, machinery, work tables, and storage racks must be properly grounded.

In the events of manual working in process, make sure the devices are well protected from ESD at any time.

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Version	Date	Summary of Revision
A1.0	10/09/2020	Datasheet set-up.